502276279 03/18/2013

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Junghoon Suh	02/19/2013
Osama Aboul-Magd	02/19/2013
Kwok Shum Au	02/19/2013

RECEIVING PARTY DATA

Name:	FutureWei Technologies, Inc.	
Street Address:	5340 Legacy Drive	
Internal Address:	Suite 175	
City:	Plano	
State/Country:	TEXAS	
Postal Code:	75024	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13771356

CORRESPONDENCE DATA

Fax Number: 9727329218

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (972)732-1001

Email: docketing@slater-matsil.com

Correspondent Name: Slater & Matsil, L.L.P.

Address Line 1: 17950 Preston Road

Address Line 2: Suite 1000

Address Line 4: Dallas, TEXAS 75252

ATTORNEY DOCKET NUMBER:	HW 83414581US02
NAME OF SUBMITTER:	Claudette Hoffmann

Total Attachments: 2

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PATENT REEL: 030035 FRAME: 0296 H \$40,00 13771

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, FutureWei Technologies, Inc. ("FutureWei"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said FutureWei, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said FutureWei, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to FutureWei, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said FutureWei, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention or the file history thereof, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said FutureWei, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Dual-Stream Signal (SIG) Field Encoding with Higher Order Modulation			
SIGNATURE OF INVENTOR AND NAME	Suhim	S. Soul Hep		
	Junghoon Suh	Osama Aboul-Magd	Kwok Shum Au	
DATE	19 Fieb 2013	Feb. 19,2013		
RESIDENCE (City, State)	Kanata, ON	Kanata, ON	Shenzhen, CN	

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made; and

WHEREAS, FutureWei Technologies, Inc. ("FutureWei"), a corporation organized and existing under the laws of Texas, with its principal office at 5340 Legacy Drive, Suite 175, Plano, TX 75024, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon in the United States and all other countries throughout the world;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said FutureWei, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner for Patents to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said FutureWei, as assignee of my entire right, title and interest. I declare that I have not executed and will not execute any agreement in conflict herewith.

I also hereby sell and assign to FutureWei, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including, but not limited to, the right to file applications and obtain patents under the terms of the International Convention for the Protection of Industrial Property, and of the European Patent Convention, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

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IN WITNESS WHEREOF, I hereunto set my hand and seal this day and year;

TITLE OF INVENTION	Dual-Stream Signal (SIG) Field Encoding with Higher Order Modulation		
SIGNATURE OF INVENTOR AND NAME	Junghoon Suh	Osama Aboul-Magd	Kwok Shum Au
DATE			Feb 19, 2013
RESIDENCE (City, State)	Kanata, ON	Kanata, ON	Shenzhen, CN

RECORDED: 03/18/2013